

# 6N137 OPTOCOUPLER/OPTOISOLATOR

SOOS003 D291B, JULY 1986

- Gallium Arsenide Phosphide LED Optically Coupled to Integrated Circuit Detector
- Compatible with TTL and LSTTL Inputs
- Low Input Current Required to Turn Output On . . . 5 mA Max
- High-Voltage Electrical Insulation . . . 3000 V DC Min
- High-Speed Switching . . . 75 ns Max
- Plastic Dual-In-Line Package
- UL Recognized . . . File Number 65085

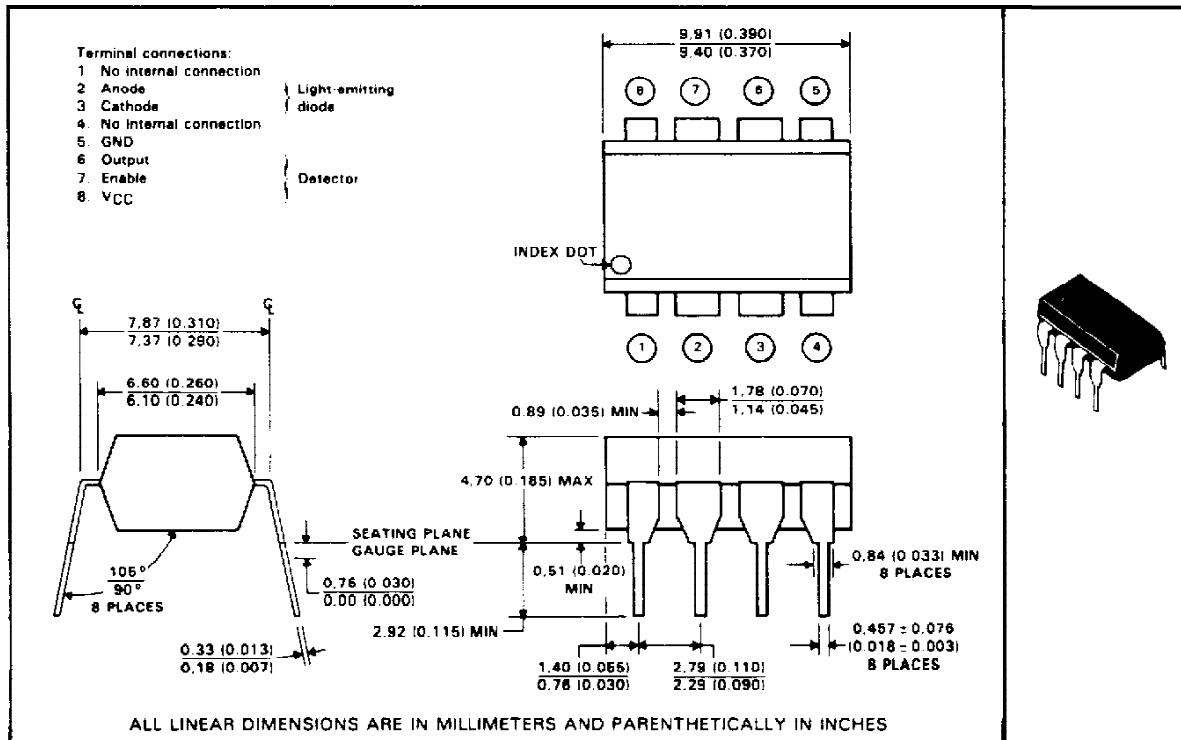
## description

The 6N137 optocoupler is designed for use in high-speed digital interfacing applications that require high-voltage isolation between the input and output. Applications include line receivers, microprocessors or computer interface, digital programming of floating power supplies, motors, and other control systems.

The 6N137 high-speed optocoupler consists of a GaAsP light-emitting diode and an integrated light detector composed of a photodiode, a high-gain amplifier, and a Schottky-clamped open-collector output transistor. An input diode forward current of 5 milliamperes will switch the output transistor low, providing an on-state drive current of 13 milliamperes (eight 1.6-milliampere TTL loads). A TTL-compatible enable input is provided for applications that require output-transistor gating.

The 6N137 is characterized for operation over the temperature range of 0°C to 70°C.

## \*mechanical data



\*JEDEC registered data. This data sheet contains all applicable registered data in effect at the time of publication.

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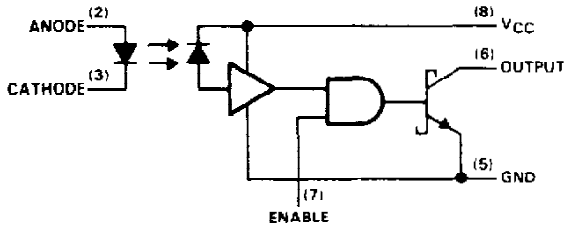
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**6N137**  
**OPTOCOUPLER/OPTOISOLATOR**

**FUNCTION TABLE**

INPUT	ENABLE	OUTPUT
I <sub>F(on)</sub>	H	L
I <sub>F(off)</sub>	X	H
X	L	H

**logic diagram (positive logic)**



**\*absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

Supply voltage, V <sub>CC</sub> .....	7 V
Reverse input voltage .....	5 V
Enable input voltage (not to exceed V <sub>CC</sub> by more than 500 mV) .....	5.5 V
Output voltage .....	7 V
Peak forward input current (≤ 1 ms duration) (TI-guaranteed value) .....	40 mA
(JEDEC-registered value) .....	20 mA
Average forward input current (TI-guaranteed value) .....	20 mA
(JEDEC-registered value) .....	10 mA
Output current .....	50 mA
Output power dissipation .....	85 mW
Storage temperature range .....	-55 °C to 125 °C
Operating free-air temperature range .....	0 °C to 70 °C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds .....	260 °C

\*JEDEC registered data

**recommended operating conditions**

		MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Output supply voltage (see Note 1)	4.5	5	5.5	V
V <sub>IH(EN)</sub>	High-level enable input voltage (see Note 2)	2		V <sub>CC</sub>	V
V <sub>IL(EN)</sub>	Low-level enable input voltage	0		0.8	V
I <sub>F(on)</sub>	Input forward current to turn output on	6.3		15	mA
I <sub>F(off)</sub>	Input forward current to turn output off	0		250	μA
I <sub>OL</sub>	Low-level (on-state) output current			13	mA
T <sub>A</sub>	Operating free-air temperature	0		70	°C

- NOTES: 1. All voltage values are with respect to GND (pin 5).  
 2. No external pullup is required at the enable input; an open circuit will establish the high level.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
*V <sub>F</sub> Input forward voltage	I <sub>F</sub> = 10 mA, T <sub>A</sub> = 25°C		1.6	1.75	V
αV <sub>F</sub> Temperature coefficient of forward voltage	I <sub>F</sub> = 10 mA		-1.8		mV/°C
*V <sub>BR</sub> Input reverse breakdown voltage	I <sub>R</sub> = 10 μA, T <sub>A</sub> = 25°C	5			V
*V <sub>OL</sub> Low-level output voltage	V <sub>CC</sub> = 5.5 V, V <sub>(EN)</sub> = 2 V, I <sub>F</sub> = 5 mA, I <sub>OL</sub> = 13 mA		0.23	0.6	V
*I <sub>OH</sub> High-level output current	V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V, V <sub>(EN)</sub> = 2 V, I <sub>F</sub> = 250 μA			250	μA
I <sub>H(EN)</sub> High-level enable input current	V <sub>CC</sub> = 5.5 V, V <sub>(EN)</sub> = 2 V		-0.2		mA
*I <sub>L(EN)</sub> Low-level enable input current	V <sub>CC</sub> = 5.5 V, V <sub>(EN)</sub> = 0.5 V		-0.5	-2	mA
*I <sub>CCH</sub> Supply current, high-level output	V <sub>CC</sub> = 5.5 V, V <sub>(EN)</sub> = 0.5 V, I <sub>F</sub> = 0		10	15	mA
*I <sub>CCL</sub> Supply current, low-level output	V <sub>CC</sub> = 5.5 V, V <sub>(EN)</sub> = 0.5 V, I <sub>F</sub> = 10 mA		13	18	mA
*I <sub>IO</sub> Input-output insulation leakage current	V <sub>IO</sub> = 3000 V, t = 5 s, T <sub>A</sub> = 25°C, RH = 45%, See Note 1			1	μA
r <sub>IO</sub> Input-output resistance	V <sub>IO</sub> = 500 V, T <sub>A</sub> = 25°C, See Note 1		10 <sup>12</sup>		Ω
C <sub>i</sub> Input capacitance	V <sub>F</sub> = 0, f = 1 MHz		60		pF
C <sub>IO</sub> Input-output capacitance	f = 1 MHz, T <sub>A</sub> = 25°C, See Note 1		0.6		pF

\*JEDEC registered data

† All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

NOTE 1: These parameters are measured between pins 2 and 3 shorted together and pins 5, 6, 7, and 8 shorted together.

switching characteristics at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

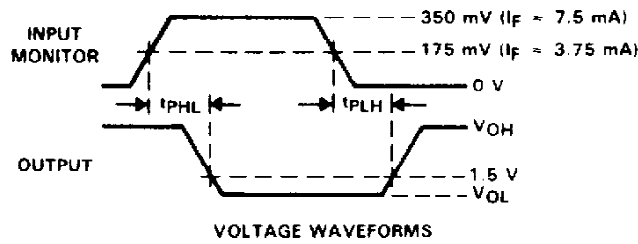
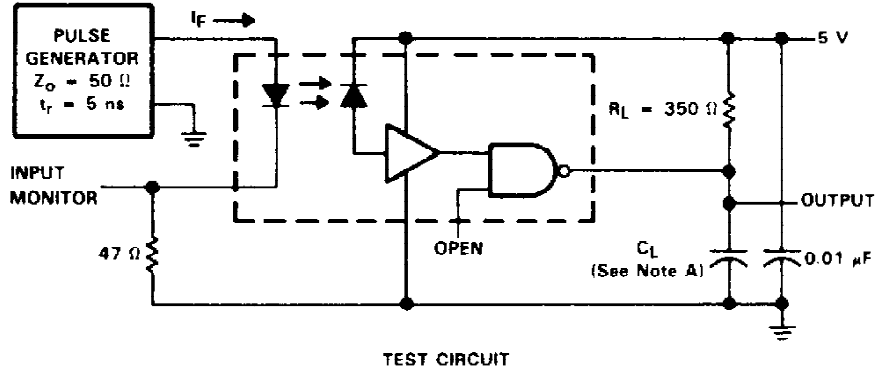
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
*t <sub>PLH</sub> Propagation delay time, low-to-high-level output, from LED input	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF, See Figure 1		42	75	ns
*t <sub>PHL</sub> Propagation delay time, high-to-low level output, from LED input	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF, See Figure 1		42	75	ns
t <sub>PLH(EN)</sub> Propagation delay time, low-to-high level output, from enable	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF, See Figure 2		40		ns
t <sub>PHL(EN)</sub> Propagation delay time, high-to-low-level output, from enable	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF, See Figure 2		25		ns
t <sub>r</sub> Rise time	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF		20		ns
t <sub>f</sub> Fall time	I <sub>F</sub> = 7.5 mA, R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF		30		ns
$\frac{dV_{CM}}{dt}$ (H) Common mode input transient immunity, high-level output	ΔV <sub>CM</sub> = 10 V, I <sub>F</sub> = 0, R <sub>L</sub> = 350 Ω, See Note 2 and Figure 3		50		V/μs
$\frac{dV_{CM}}{dt}$ (L) Common-mode input transient immunity, low-level output	ΔV <sub>CM</sub> = -10 V, I <sub>F</sub> = 5 mA, R <sub>L</sub> = 350 Ω, See Note 2 and Figure 3		-150		V/μs

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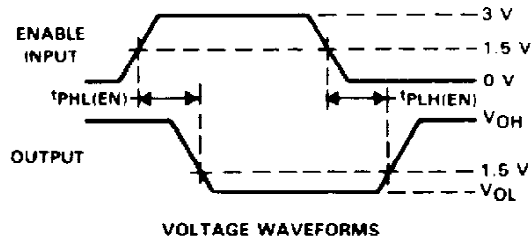
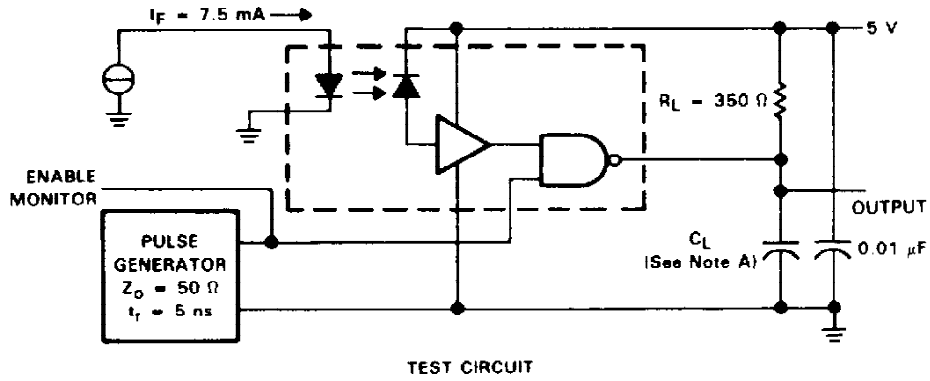
NOTE 2: Common-mode input transient immunity, high-level output, is the maximum rate of rise of the common-mode input voltage that does not cause the output voltage to drop below 2 V. Common-mode input transient, low-level output, is the maximum rate of fall of the common-mode input voltage that does not cause the output voltage to rise above 0.8 V.

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**PARAMETER MEASUREMENT INFORMATION**



**FIGURE 1. t<sub>PLH</sub> AND t<sub>PHL</sub> FROM LED INPUT TEST CIRCUIT AND WAVEFORMS**



**FIGURE 2. t<sub>PLH(EN)</sub> AND t<sub>PHL(EN)</sub> FROM ENABLE TEST CIRCUIT AND WAVEFORMS**

NOTE A: C<sub>L</sub> is approximately 15 pF, which includes probe and stray wiring capacitances.

PARAMETER MEASUREMENT INFORMATION

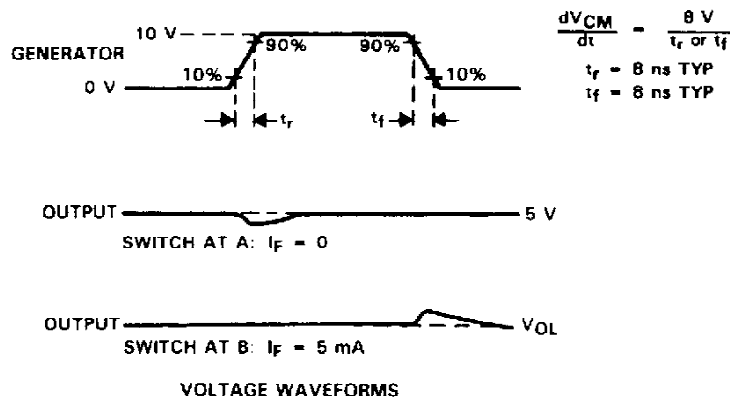
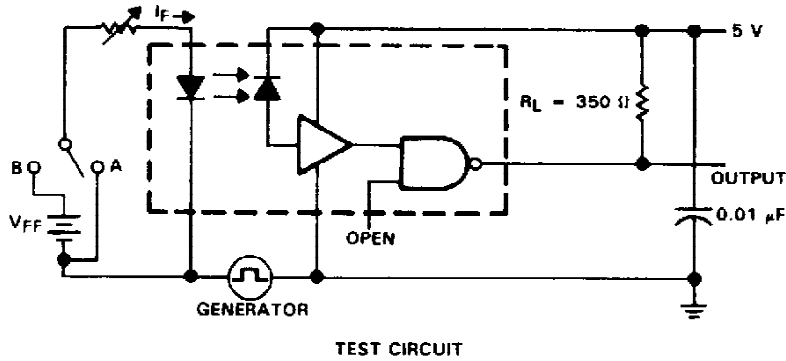


FIGURE 3. TRANSIENT IMMUNITY TEST CIRCUIT AND WAVEFORMS

TYPICAL APPLICATION INFORMATION

A ceramic capacitor (0.01  $\mu\text{F}$  to 0.1  $\mu\text{F}$ ) should be connected between pins 8 and 5 to stabilize the high-gain amplifier. The total lead length between the capacitor and the optocoupler should not exceed 20 mm (0.8 inches). Failure to provide a bypass capacitor may result in impaired switching characteristics.

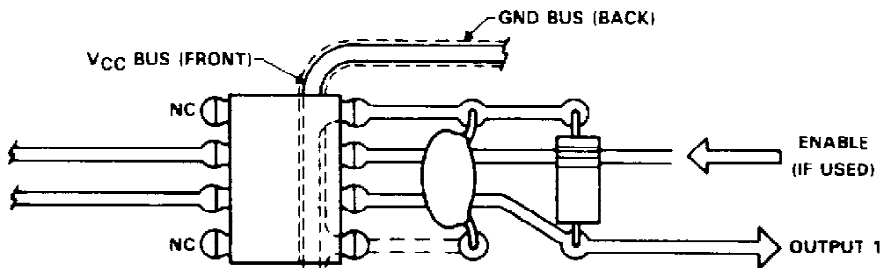


FIGURE 4. RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT

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**TYPICAL CHARACTERISTICS**

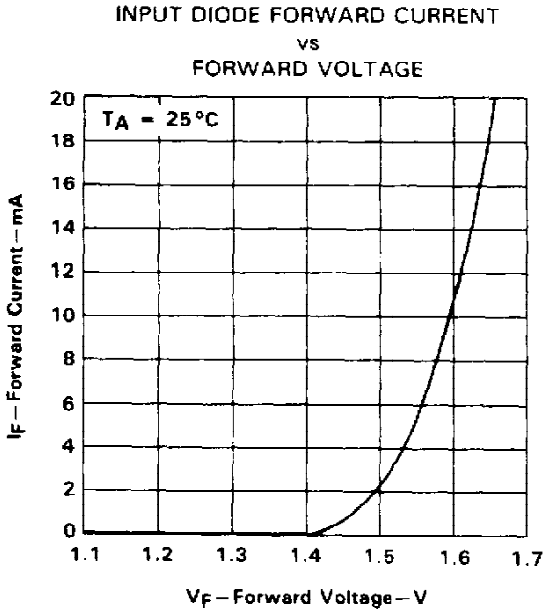


FIGURE 5

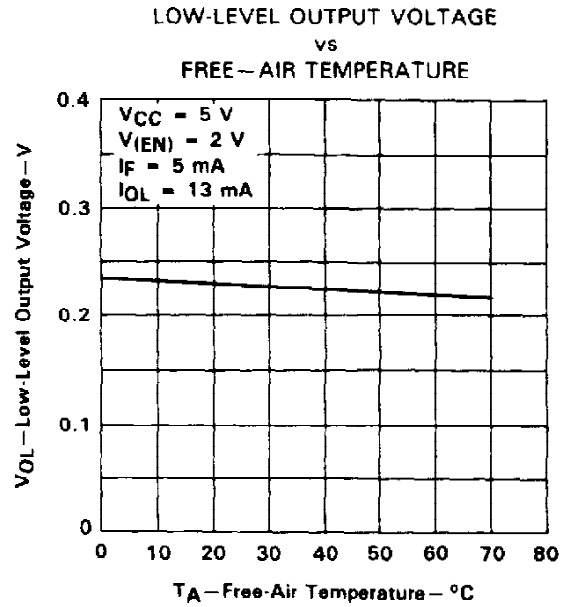


FIGURE 6

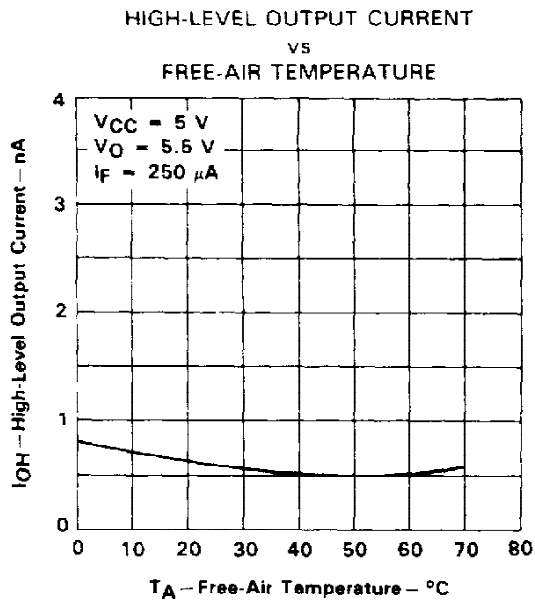


FIGURE 7

TYPICAL CHARACTERISTICS

PROPAGATION DELAY TIME FROM LED INPUT  
vs  
PULSE FORWARD CURRENT

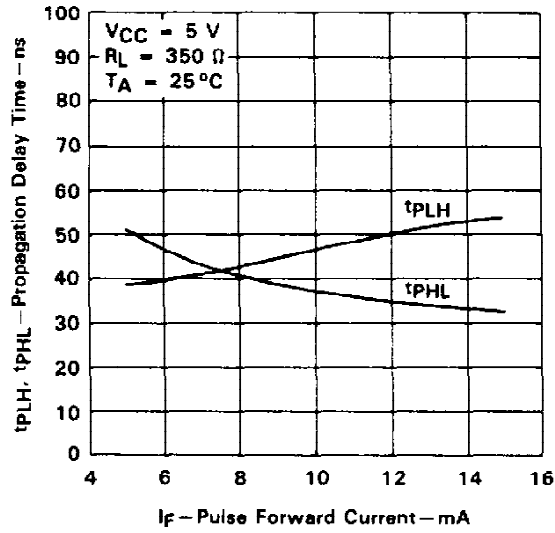


FIGURE 8

PROPAGATION DELAY TIME FROM LED INPUT  
vs  
LOAD RESISTANCE

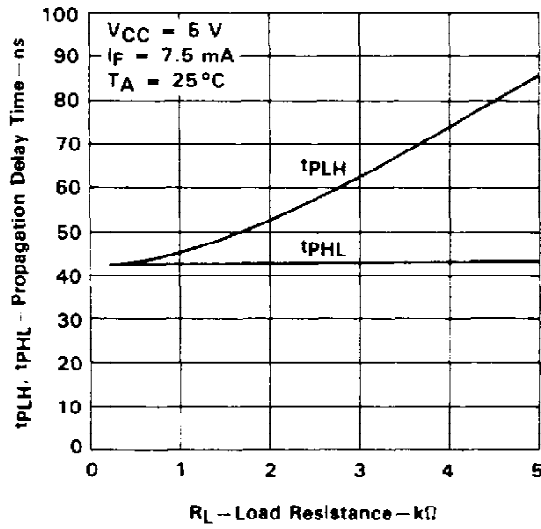


FIGURE 9

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